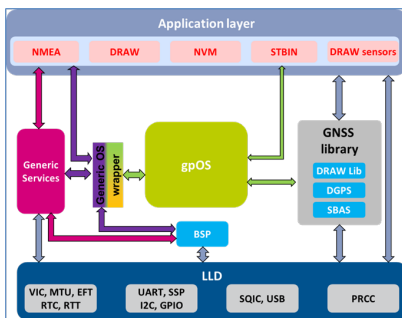


## Teseo-VIC3D firmware for Teseo-VIC3D/DA Dead-Reckoning GNSS module



### Features

- Communication interface:
  - UART
  - I2C
- Protocols:
  - NMEA
- Multi-constellation:
  - GPS
  - Glonass
  - Galileo
  - BeiDou
  - QZSS
- Assisted GNSS
  - Autonomous AGNSS
  - Predictive AGNSS
  - RealTime AGNSS
- Odometer
- Data logging
- Geofencing

### Product status link

[Teseo-VIC3DSW](#)

### Description

This package contains the latest released firmware for Teseo-VIC3D Dead-Reckoning GNSS module.

This firmware must be used in combination with the Teseo Suite PC software application to perform the firmware update on the Teseo-VIC3D Dead-Reckoning GNSS module.

## Revision history

**Table 1. Document revision history**

| Date        | Revision | Changes          |
|-------------|----------|------------------|
| 07-Oct-2021 | 1        | Initial release. |

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